

Specification

MATERIAL:

Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: G3210
 Shell: SIS

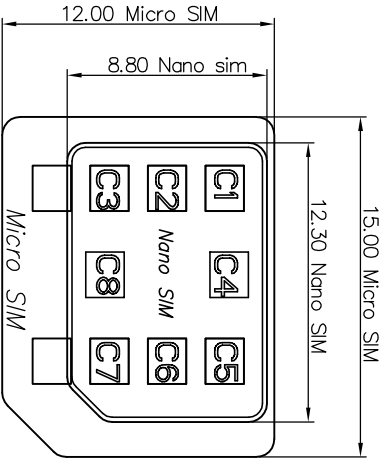
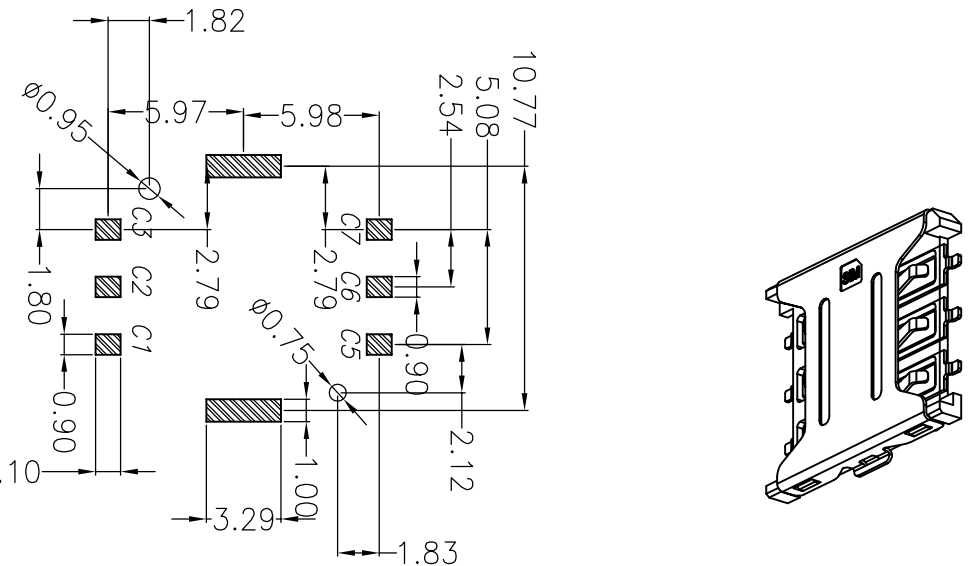
PLATING:

Contact: Plated 50µ" Ni Overall Contact All Au 1U,
 Shell: Plated 50µ" Ni Overall, PAD Au 1U

Electrical:

Current Rating : 0.5mA AC/DC max.
 Voltage Rating : 125V AC/DC
 Ambient Temperature Range : -20° C ~ +60° C
 Storage Temperature Range : -40° C ~ +70° C
 Ambient Humidity Range : 95% R.H. Max.
 Contact Resistance: 10mΩCmax.
 Insulation Resistance: 100MΩCmin./500VDC
 Mating Cycles: 10,000 Insertions
 Reflow peak temp.: 260° C ±5° C, 3"5 S
 Mating Cycles: 3,000 Insertions Min

SIM pin assignment	Pin#	Name
	C1	VCC供电电压
	C2	RST重置
	C3	CLK时钟
	C5	GND接地
	C6	VPP程序电压
	C7	I/O输入输出



台湾讯普电子科技有限公司

PRODUCT NAME: NANO-SIM 卡 NANO-PUSH 1.35H
 DRAWING NO.: COCO
 DATE: 2015/04/10

PRODUCT NO.: SMN-304
 DATE: 2015/04/11

DRAWING NO.:
 DATE: 2015/04/11
 SCALE: 1:1
 SHEET: A
 PAGE: 1 of 1

REVISION NO.	DCR NO.	DESCRIPTION	DATE
1			
2			
3			
4			
5			
6			